

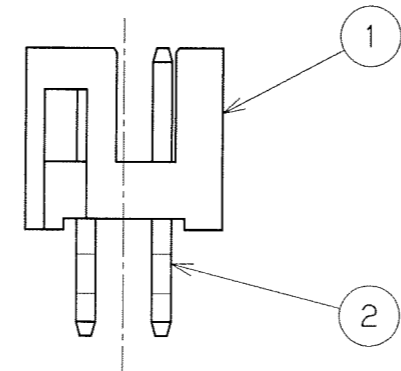
RECOMMENDED PCB LAYOUT
PCB THICKNESS t=1.6

TABLE 1

PART NO.	A	B
LPC-4PM2 ()	2	5.2
LPC-18PM2 ()	16	19.2
LPC-20PM2 ()	18	21.2
LPC-26PM2 ()	24	27.2

TABLE 2

PART NO.	PLATING
LPC- (n) PM2	TIN/LEAD 2μm
LPC- (n) PM2G	GOLD 0.2μm



NOTE1. "n" SHOWS NUMBER OF CONTACTS.

2. AS FOR THE DIMENTION, SEE TABLE #1.

△									
△	APR.05.2005	T. O	ADD P/N AND PLATING	2	CONTACT	PHOSPHOR BRONZE	n	SEE TABLE #2	
△	FEB.19.1999	K. K	26 POS. ADD	1	INSULATOR	PA66	1		UL94V-0 BLACK
LTR.	DATE	BY	REV. DESCRIPT	No.	PART NAME	MATERIAL	QTY	FINISH	NOTE
	DATE		SCALE		UNIT	3RD. A. P	HONDA TSUSHIN KOGYO CO., LTD.		
	JAN.25 (1999)		5/1		mm (INCH)				
	APP. DATE&REV.								
DR.	DE.	CHK.	CHK.	APP.	NAME	MALE CONNECTOR			
T.Oda	T.Oda	-			PART NO.	LPC- () PM2 () △			REV. 2B